

BF494 NPN RF Transistor



1. Collector 2. Emitter 3. Base

Absolute Maximum Ratings * T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit V	
V _{CEO}	Collector-Emitter Voltage	20		
V _{CBO}	Collector-Base Voltage	30	V	
V _{EBO}	Emitter-Base Voltage	5.0	5.0 V	
I _C	Collector Current - Continuous	30	mA	
TJ	Junction Temperature 150		°C	
T _{STG}	Storage Temperature Range	- 55 ~ 150 °C		

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

These ratings are based on a maximum junction temperature of 150 degrees C.
 These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations

Thermal Characteristics

Symbol	Parameter	Value	Unit
P _D	Total Device Dissipation, by R _{θJA} Derate above 25°C	350 2.8	m₩ m₩/°C
$R_{\theta JC}$	Thermal Resistance, Junction to case	125	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	357	°C/W

Electrical Characteristics* T_C = 25°C unless otherwise noted

Symbol	Parameter	Parameter Conditions Min. Max.		Max.	Units	
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	I _C = 1.0mA, I _B = 0	20		V	
V _{(BR)CBO}	Collector-Base BreakdownVoltage	$I_{\rm C} = 10 \mu {\rm A}, \ I_{\rm E} = 0$	30		V	
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_{\rm E} = 10 \mu A, I_{\rm C} = 0$	5.0		V	
I _{CES}	Collector-Emitter Sustaining Current	$V_{CE} = 40V, V_{EB} = 0V$		10	nA	
h _{FE}	DC Current Gain	$V_{CE} = 10V, I_{C} = 1mA$	67	222		
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C = 10mA, I _B = 5mA		0.2	V	
V _{BE} (sat)	Base-Emitter Saturation Voltage	I _C = 10mA, I _B = 5mA		0.92	V	
V _{BE} (ON)	Base-Emitter On Voltage	$V_{CE} = 10V, I_{C} = 10mA$	650	740	mV	

* DC Item are tested by Pulse Test: Pulse Width≤300us, Duty Cycle≤2%



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